

L Number	Hits	Search Text	DB	Time stamp
2	1	tft same interconnect and substrate same barrier and copper same seed	USPAT	2004/07/25 14:19
3	700	interconnect and substrate same barrier and copper same seed	USPAT	2004/07/25 14:20
4	326	interconnect same substrate same barrier and copper same seed	USPAT	2004/07/25 14:20